SOT-23 Plastic-Encapsulate MOSFETS

TF2301A

TF2301A P-Channel 20-V(D-S) MOSFET

$V_{(BR)DSS}$	$R_{DS(on)}$TYP	I_D
-20V	0.055Ω@-4.5V	-3.0A
	0.075Ω@-2.5V	

SOT-23

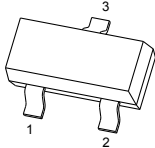1.GATE
2.SOURCE
3.DRAIN

General FEATURE

●TrenchFET Power MOSFET

●Lead free product is acquired

●Surface mount package

APPLICATION
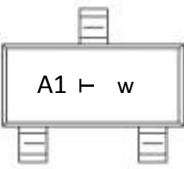
●Load Switch for Portable Devices
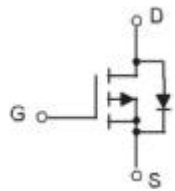
●DC/DC Converter

MARKING

Equivalent Circuit

A1 ⊢ w

*w：week code

Maximum ratings (Ta=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	±12	
Continuous Drain Current	I_D	-3. 0	A
Pulsed Drain Current	I_{DM}	-12	
Continuous Source-Drain Diode Current	I_S	-1.30	
Maximum Power Dissipation	P_D	1.25	W
Thermal Resistance from Junction to Ambient(t ≤5s)	$R_{θJA}$	165	℃/W
Junction Temperature	T_J	150	℃
Storage Temperature	T_{stg}	-55 ~+150	

MOSFET ELECTRICAL CHARACTERISTICS
T_a =25 ℃ unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Static						
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D =-250µA	-20			V
Gate-source threshold voltage	$V_{GS(th)}$	V_{DS} =V_{GS}, I_D =-250µA	-0.5	-0.7	-1	
Gate-source leakage	I_{GSS}	V_{DS} =0V, V_{GS} =±8V			±100	nA
Zero gate voltage drain current	I_{DSS}	V_{DS} =-20V, V_{GS} =0V			-1	µA
Drain-source on-state resistance [a]	$R_{DS(on)}$	V_{GS} =-4.5V, I_D =-3.0A		0.055	0.075	Ω
		V_{GS} =-2.5V, I_D =-2.0A		0.075	0.090	
Forward transconductance [a]	g_{fs}	V_{DS} =-5V, I_D =-2.0A	4.0	6.5		S
Dynamic[b]						
Input capacitance	C_{iss}	V_{DS} =-10V,V_{GS} =0V,f =1MHz		585		pF
Output capacitance	C_{oss}			70		
Reverse transfer capacitance	C_{rss}			65		
Total gate charge	Q_g	V_{DS} =-10V,V_{GS} =-4.5V,I_D =-3A		5.5	10	nC
		V_{DS} =-10V,V_{GS} =-2.5V,I_D =-2A		2.9	6	
Gate-source charge	Q_{gs}			045		
Gate-drain charge	Q_{gd}			0.75		
Gate resistance	R_g	f =1MHz		6.0		Ω
Turn-on delay time	$t_{d(on)}$	V_{DD}=-10V, R_L=5Ω, I_D =-1A, V_{GEN}=-4.5V,Rg=3Ω		9.8	20	ns
Rise time	t_r			4.9	60	
Turn-off delay time	$t_{d(off)}$			20.5	50	
Fall time	t_f			7.0	20	
Drain-source body diode characteristics						
Continuous source-drain diode current	I_S	T_C=25℃			-1.3	A
Pulse diode forward current [a]	I_{SM}				-10	
Body diode voltage	V_{SD}	I_S=-1.0A		-0.8	-1.2	V

Notes :

a.Pulse Test : Pulse Width < 300µs, Duty Cycle ≤2%.

b.Guaranteed by design, not subject to production testing.

SOT-23 Plastic-Encapsulate MOSFETS

TF2301A
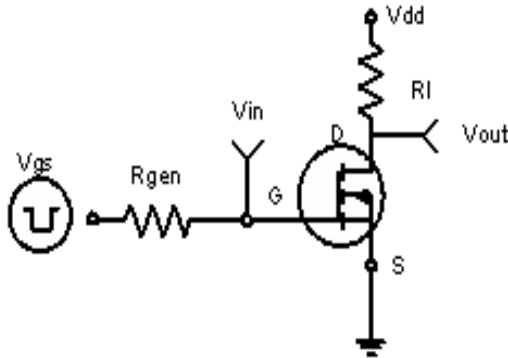
Typical Electrical and Thermal Characteristics
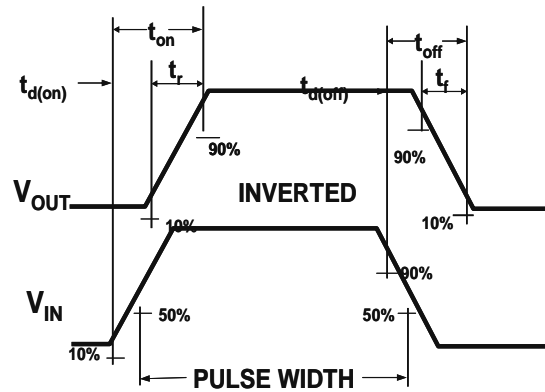

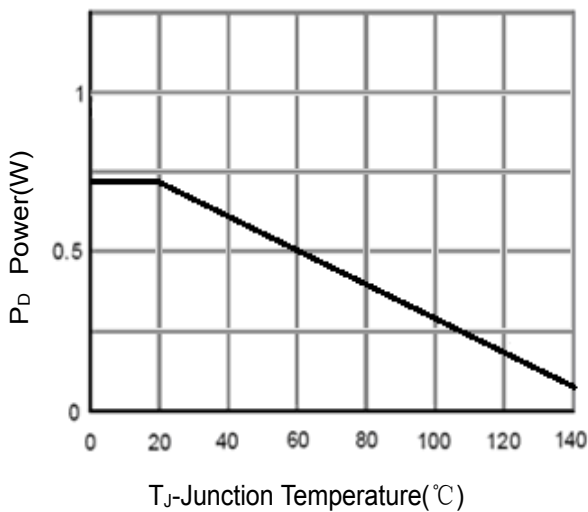**Figure 1:Switching Test Circuit**

Figure 2:Switching Waveforms

T_J-Junction Temperature(℃)

Figure 3 Power Dissipation

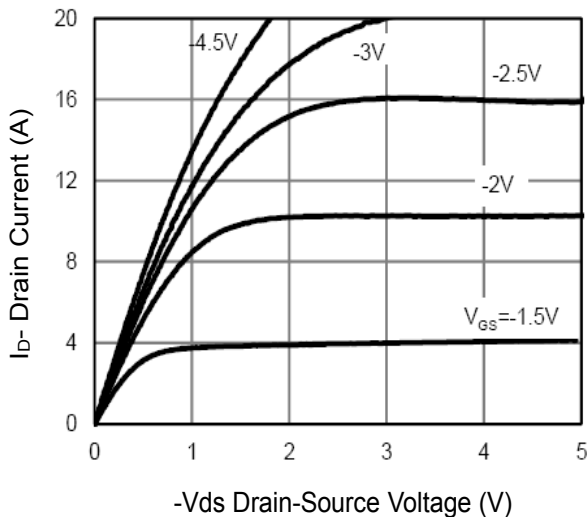T_J-Junction Temperature(℃)

Figure 4 Drain Current

-Vds Drain-Source Voltage (V)
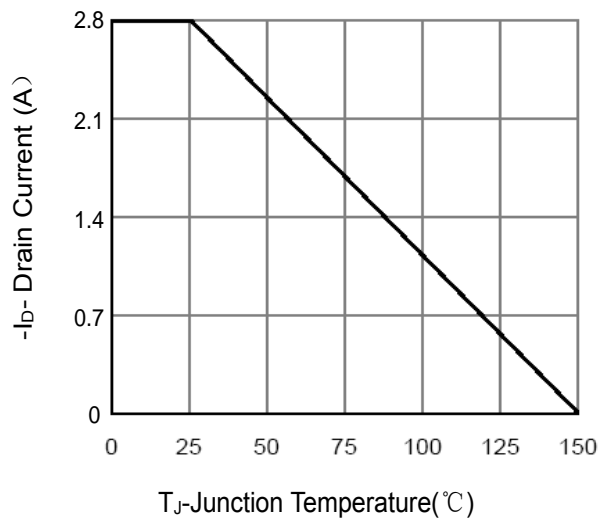
Figure 5 Output Characteristics

-I_D- Drain Current (A)
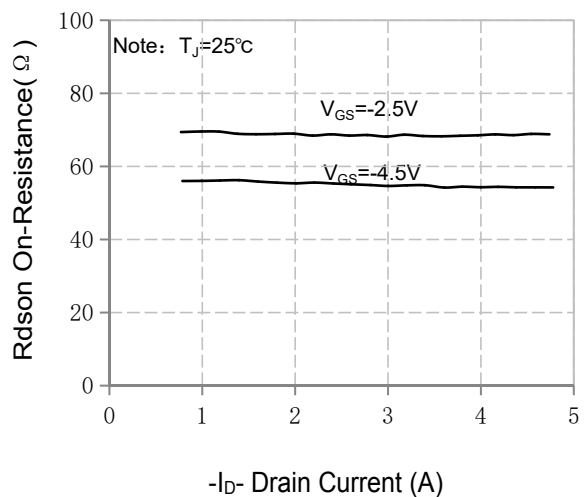
Figure 6 Drain-Source On-Resistance

Figure 7 Transfer Characteristics

Figure 8 Drain-Source On-Resistance

Figure 9 Rdson vs Vgs

Figure 10 Capacitance vs Vds

Figure 11 Gate Charge
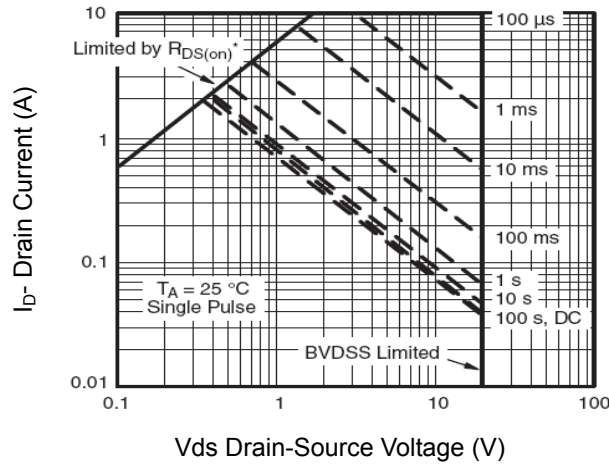

Figure 12 Source- Drain Diode Forward
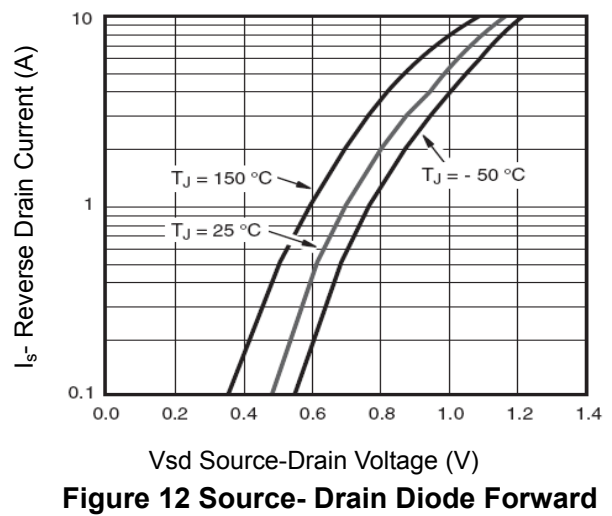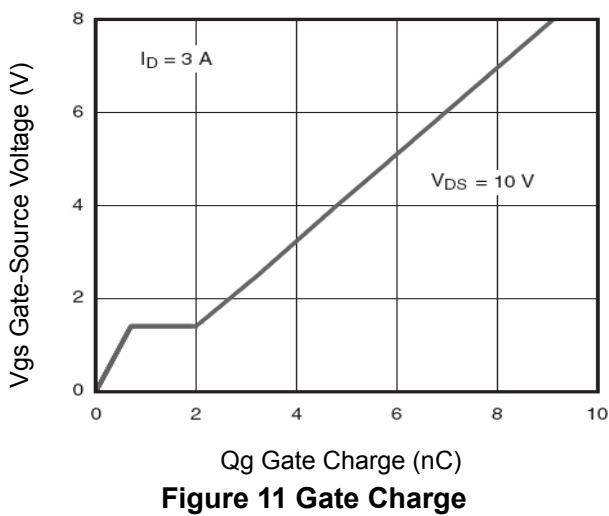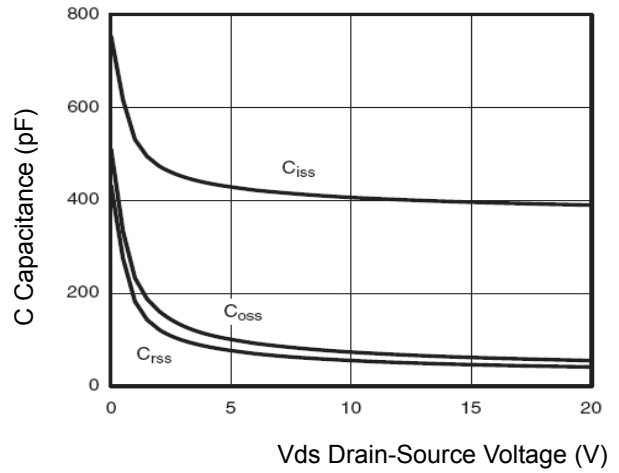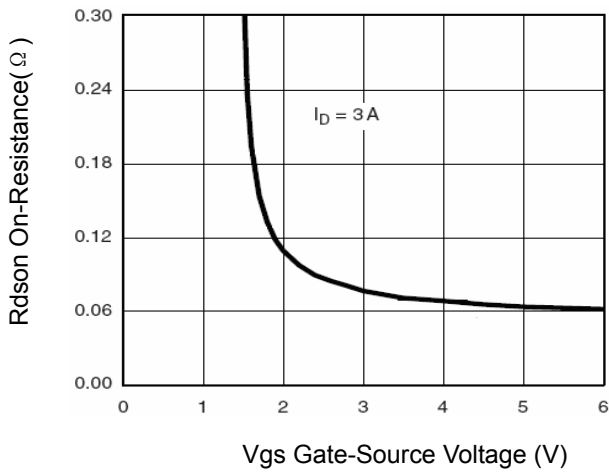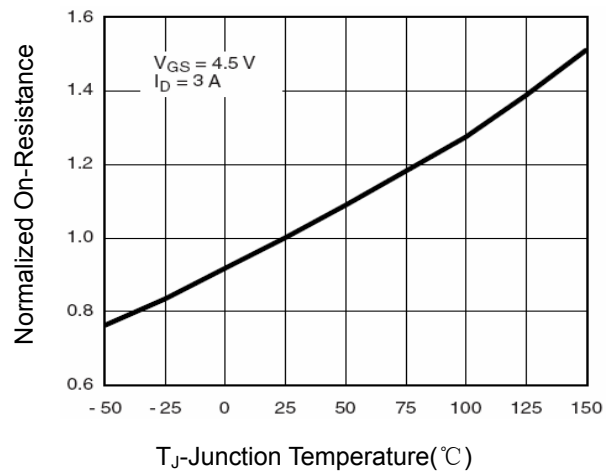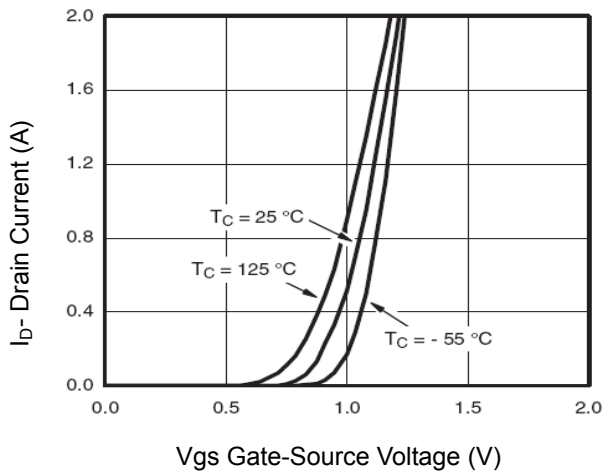
Figure 13   Safe Operation Area
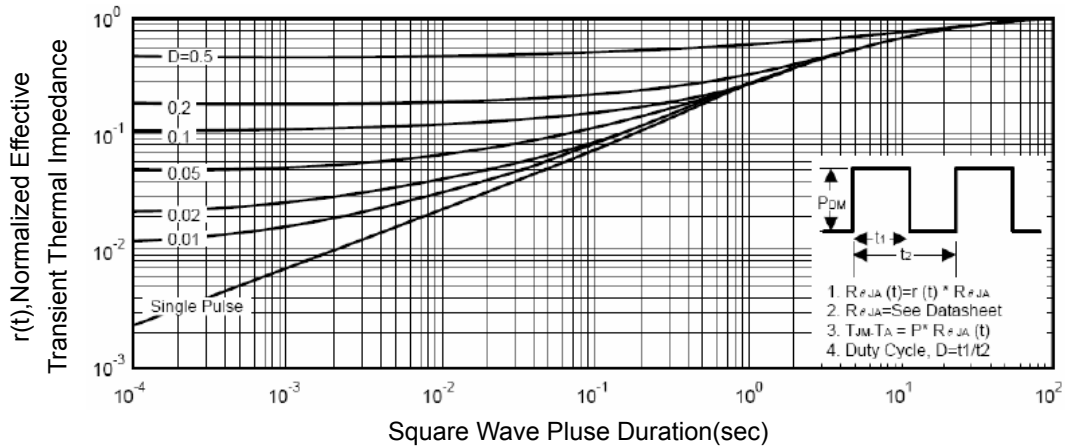
Figure 14 Normalized Maximum Transient Thermal Impedance

SOT-23 Package Outline Dimensions
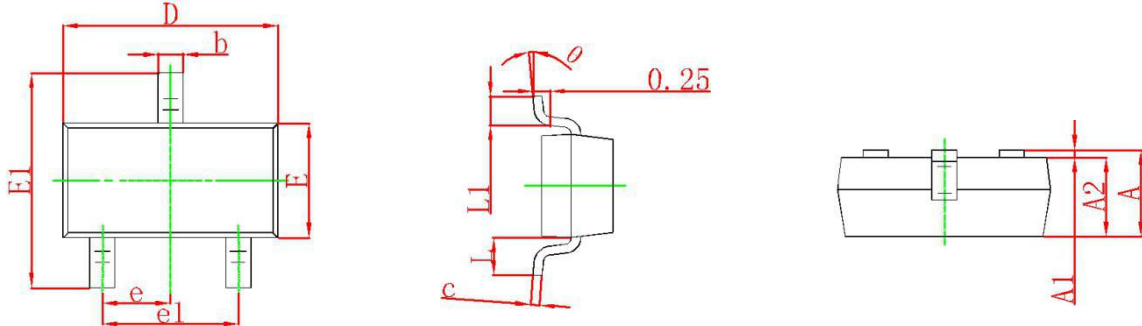
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout
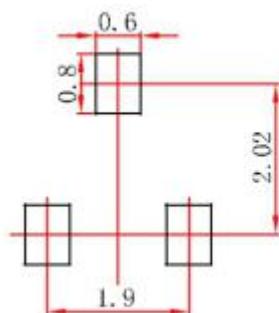
Note:
1.Controlling dimension:in millimeters.
2.General tolerance:± 0.05mm.
3.The pad layout is for reference purposes only.